

## 2.5V micropower shunt voltage reference

### Features

- 2.50V typical output voltage
- Ultra low current consumption: 40µA typ.
- High precision @ 25°C
  - ±2% (standard version)
  - ±1% (A grade)
- High stability when used with capacitive loads
- Industrial temperature range: -40°C to +85°C
- 100ppm/°C maximum temperature coefficient

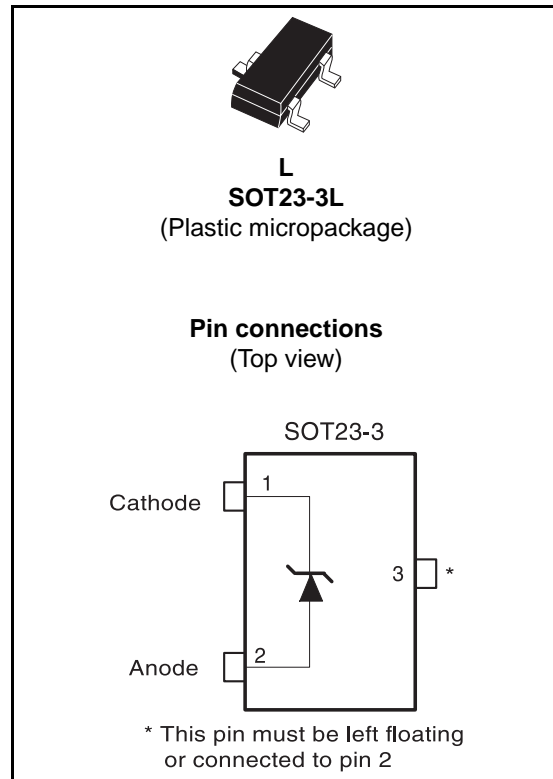
### Applications

- Computers
- Instrumentation
- Battery chargers
- Switch mode power supply
- Battery operated equipment

### Description

The TS822 is a low power shunt voltage reference providing a stable 2.5V output voltage over the industrial temperature range (-40°C to +85°C). Available in SOT23-3 surface mount package, it can be designed in applications where space saving is critical.

The low operating current is a key advantage for power restricted designs. In addition, the TS822 is very stable and can be used in a broad range of application conditions.



# 1 Absolute maximum ratings and operating conditions

**Table 1. Absolute maximum ratings**

Symbol	Parameter	Value	Unit
$I_k$	Reverse breakdown current	20	mA
$I_f$	Forward current	10	mA
$P_d$	Power dissipation <sup>(1)</sup> SOT23-3	360	mW
$T_{stg}$	Storage temperature	-65 to +150	°C
ESD	Human body model (HBM) <sup>(2)</sup>	2	kV
	Machine model (MM) <sup>(3)</sup>	200	V
$T_{lead}$	Lead temperature (soldering, 10 seconds)	260	°C

- $P_d$  is calculated with  $T_{amb} = 25^\circ\text{C}$  and  $R_{thja} = 340^\circ\text{C/W}$  for the SOT23-3L package
- Human body model: 100pF discharged through a 1.5k $\Omega$  resistor between two pins of the device, done for all couples of pin combinations with other pins floating.
- Machine model: a 200pF cap is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor < 5 $\Omega$ ), done for all couples of pin combinations with other pins floating.

**Table 2. Operating conditions**

Symbol	Parameter	Value	Unit
$I_{k-min}$	Minimum operating current	50	$\mu\text{A}$
$I_{k-max}$	Maximum operating current	15	mA
$T_{oper}$	Operating free air temperature range	-40 to +85	°C

## 2 Electrical characteristics

**Table 3. TS822 (2% precision)  $T_{amb} = 25^{\circ}\text{C}^{(1)}$  (unless otherwise specified)**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_k$	Reverse breakdown voltage	$I_k = 100\mu\text{A}$	2.45	2.5	2.55	V
	Reverse breakdown voltage tolerance	$I_k = 100\mu\text{A}$ $-40^{\circ}\text{C} < T_{amb} < +85^{\circ}\text{C}$	-50 -66		50 66	mV
$I_{k-min}$	Minimum operating current	$T = 25^{\circ}\text{C}$		40	50	$\mu\text{A}$
		$-40^{\circ}\text{C} < T_{amb} < +85^{\circ}\text{C}$			60	
$\Delta V_{ref}/\Delta T$	Average temperature coefficient	$I_k = 100\mu\text{A}$		30	100	ppm/ $^{\circ}\text{C}$
$\Delta V_k/\Delta I_k$	Reverse breakdown voltage change with operating current range	$I_{k-min} < I_k < 1\text{mA}$ $-40^{\circ}\text{C} < T_{amb} < +85^{\circ}\text{C}$		0.4	1 1.2	mV
		$1\text{mA} < I_k < 15\text{mA}$ $-40^{\circ}\text{C} < T_{amb} < +85^{\circ}\text{C}$		2.5	8 10	
$R_{ka}$	Reverse static impedance	$I_k = I_{k-min}$ to $1\text{mA}$ $-40^{\circ}\text{C} < T_{amb} < +85^{\circ}\text{C}$		0.4	1 1.2	$\Omega$
		$I_k = 1$ to $15\text{mA}$ $-40^{\circ}\text{C} < T_{amb} < +85^{\circ}\text{C}$		0.2	0.6 0.7	
$K_{vh}$	Long term stability	$I_k = 100\mu\text{A}$ , $t = 1000\text{hrs}$		120		ppm
$E_n$	Wide band noise	$I_k = 100\mu\text{A}$ , $10\text{Hz} < f < 10\text{kHz}$		35		nV/ $\sqrt{\text{Hz}}$

1. Limits are 100% production tested at  $25^{\circ}\text{C}$ . Behavior at temperature range limits is guaranteed by correlation and design.

**Table 4. TS822A (1% precision)  $T_{amb} = 25^{\circ}\text{C}^{(1)}$  (unless otherwise specified)**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_k$	Reverse breakdown voltage	$I_k = 100\mu\text{A}$	2.475	2.5	2.525	V
	Reverse breakdown voltage tolerance	$I_k = 100\mu\text{A}$ $-40^{\circ}\text{C} < T_{amb} < +85^{\circ}\text{C}$	-25 -41		25 41	mV
$I_{k-min}$	Minimum operating current	$T = 25^{\circ}\text{C}$		40	50	$\mu\text{A}$
		$-40^{\circ}\text{C} < T_{amb} < +85^{\circ}\text{C}$			60	
$\Delta V_{ref}/\Delta T$	Average temperature coefficient	$I_k = 100\mu\text{A}$		30	100	ppm/ $^{\circ}\text{C}$
$\Delta V_k/\Delta I_k$	Reverse breakdown voltage change with operating current range	$I_{k-min} < I_k < 1\text{mA}$ $-40^{\circ}\text{C} < T_{amb} < +85^{\circ}\text{C}$		0.4	1 1.2	mV
		$1\text{mA} < I_k < 15\text{mA}$ $-40^{\circ}\text{C} < T_{amb} < +85^{\circ}\text{C}$		2.5	8 10	
$R_{ka}$	Reverse static impedance	$I_k = I_{k-min}$ to $1\text{mA}$ $-40^{\circ}\text{C} < T_{amb} < +85^{\circ}\text{C}$		0.4	1 1.2	$\Omega$
		$I_k = 1\text{mA}$ to $15\text{mA}$ $-40^{\circ}\text{C} < T_{amb} < +85^{\circ}\text{C}$		0.2	0.6 0.7	
$K_{vh}$	Long term stability	$I_k = 100\mu\text{A}$ , $t = 1000\text{hrs}$		120		ppm
$E_n$	Wide band noise	$I_k = 100\mu\text{A}$ , $10\text{Hz} < f < 10\text{kHz}$		35		nV/ $\sqrt{\text{Hz}}$

1. Limits are 100% production tested at  $25^{\circ}\text{C}$ . Behavior at temperature range limits is guaranteed by correlation and design.

Figure 1. Reference voltage versus cathode current

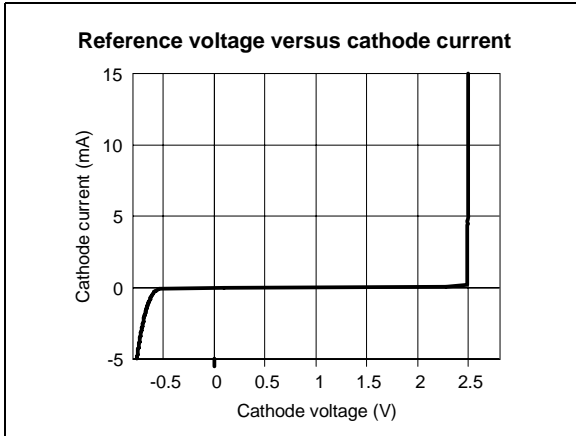


Figure 2. Minimum operating current

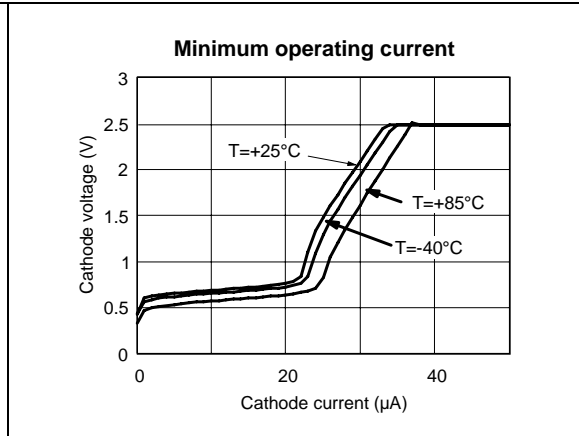


Figure 3. Test circuit

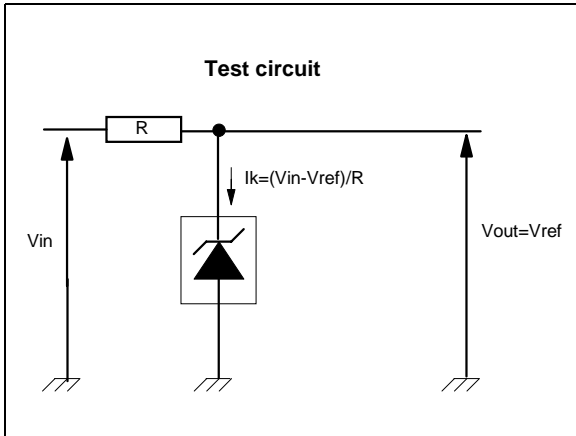


Figure 4. Reference voltage versus temperature

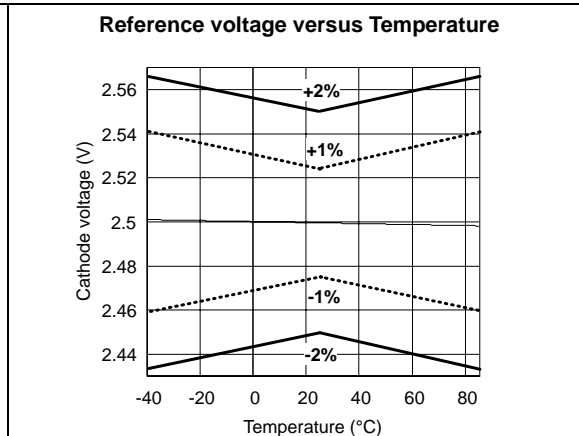


Figure 5. Static impedance ( $R_{ka}$ ) versus temperature

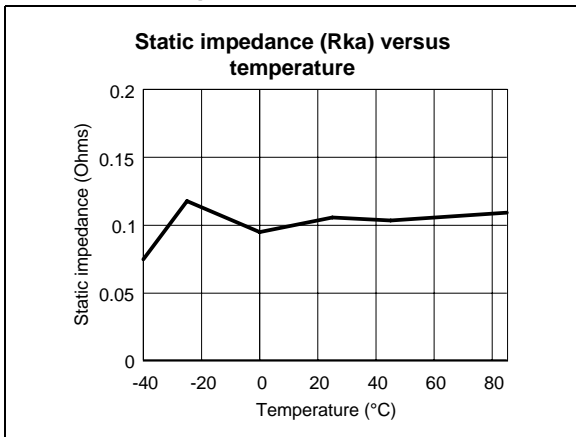


Figure 6. Noise voltage versus frequency

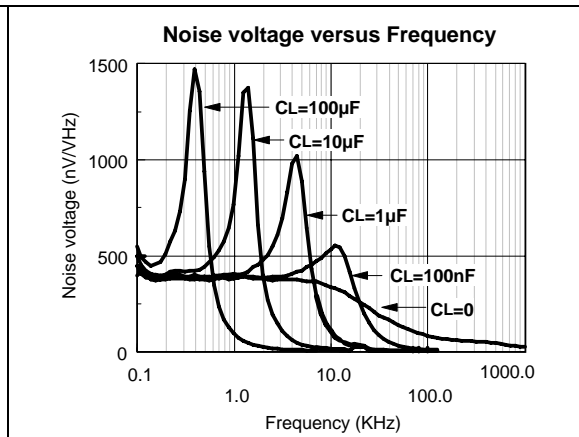


Figure 7. Test circuit for pulse response at  $I_k=100\mu A$

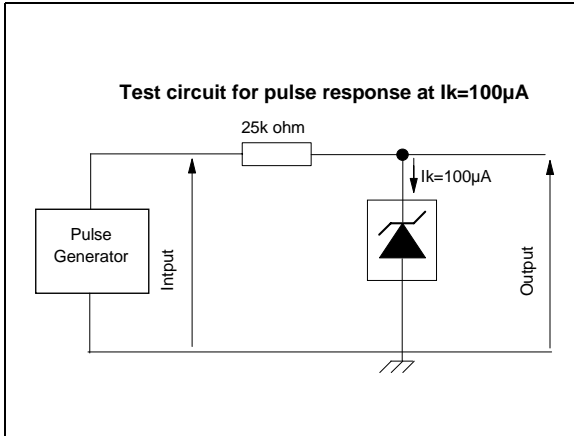


Figure 8. Pulse response for  $I_k=100\mu A$

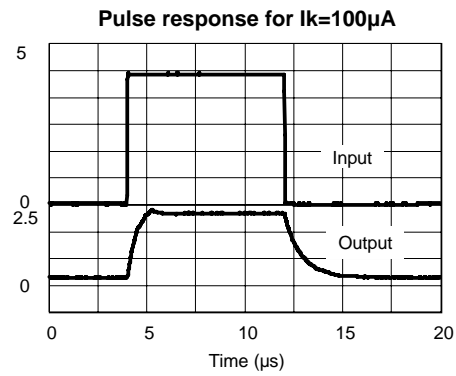


Figure 9. Pulse response for  $I_k=100\mu A$  (detailed part)

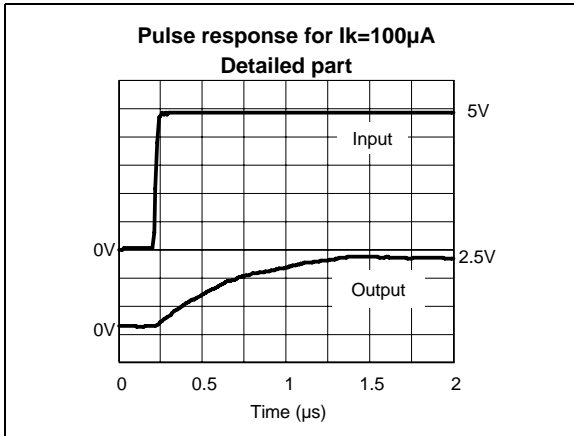


Figure 10. Pulse response for  $I_k=100\mu A$  (detailed part)

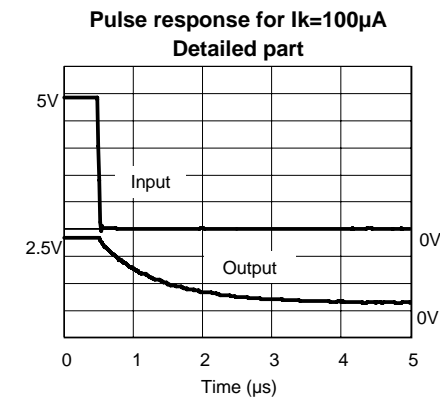


Figure 11. Test circuit for pulse response at  $I_k=100mA$

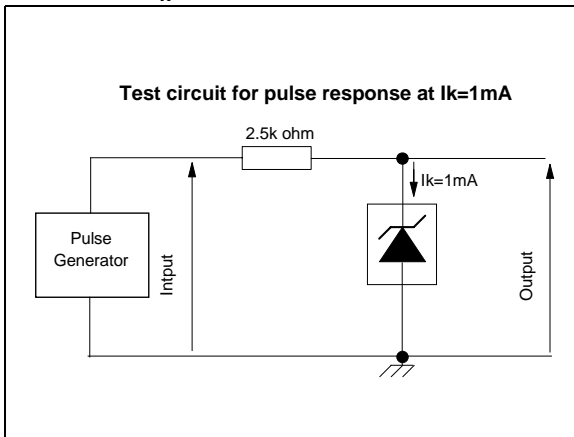


Figure 12. Pulse response for  $I_k=100mA$

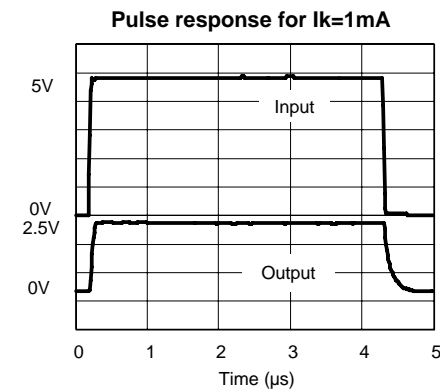


Figure 13. Pulse response for  $I_k=100\text{mA}$  (detailed part)

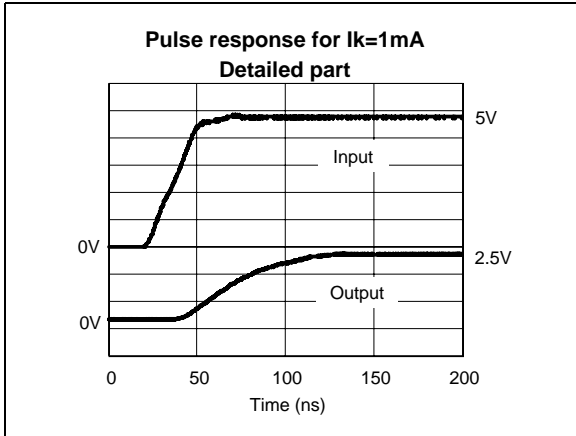
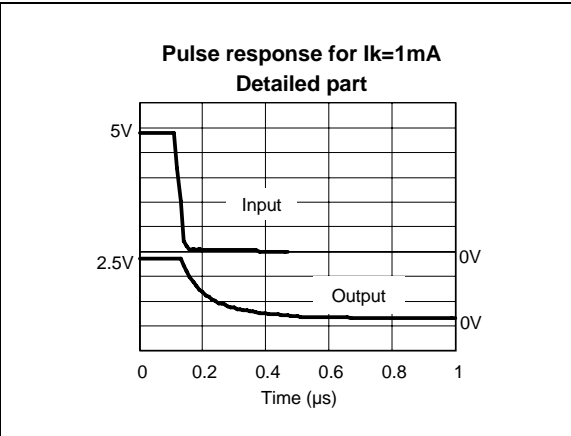


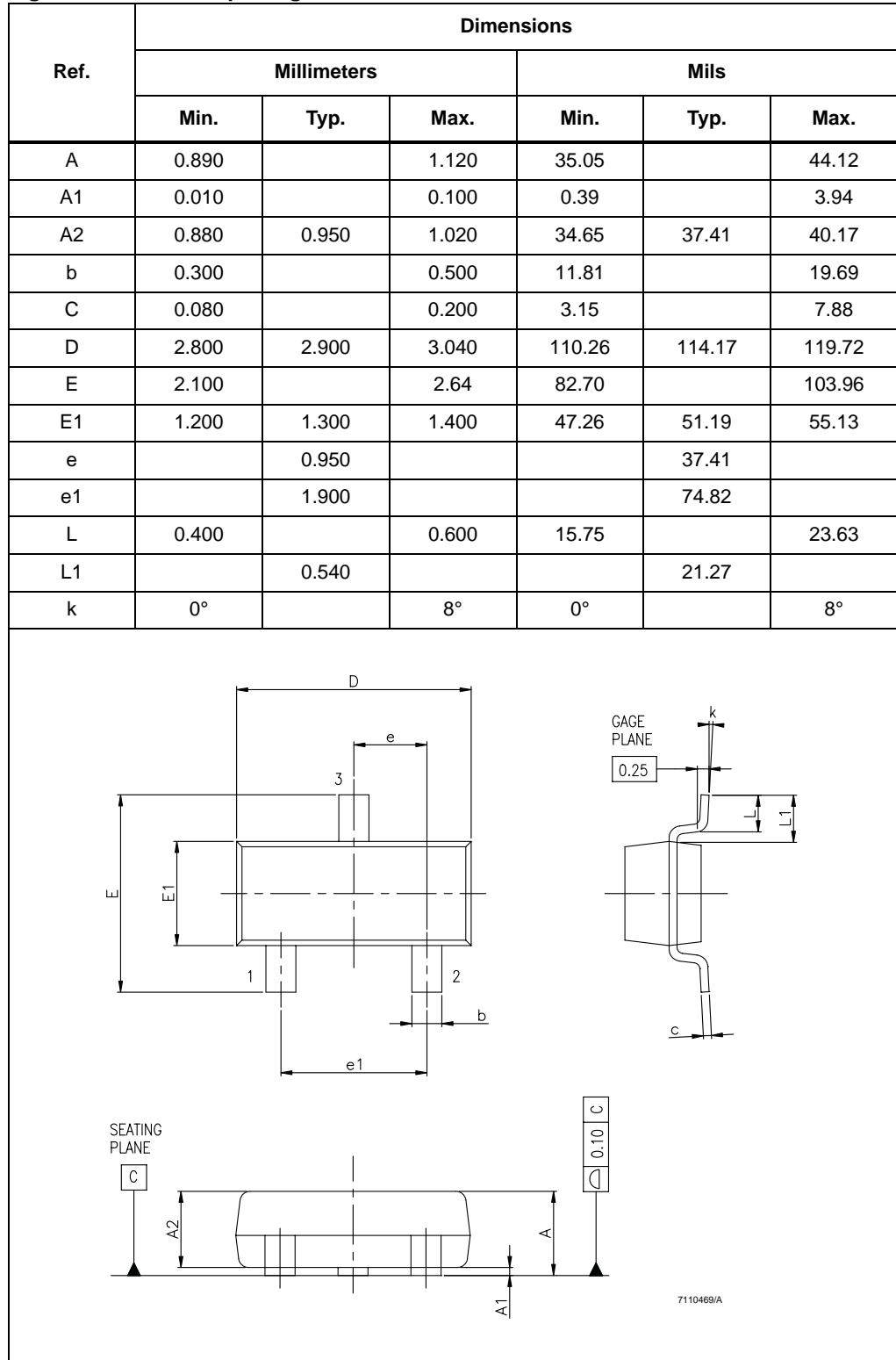
Figure 14. Pulse response for  $I_k=100\text{mA}$  (detailed part)



### 3 Package information

In order to meet environmental requirements, STMicroelectronics offers these devices in ECOPACK<sup>®</sup> packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an STMicroelectronics trademark. ECOPACK specifications are available at: [www.st.com](http://www.st.com).

Figure 15. SOT23-3 package mechanical data



## 4 Ordering information

**Table 5. Order codes**

Part number	Precision	Temperature range	Package	Packing	Marking
TS822ILT	2%	-40°C to +85°C	SOT23-3	Tape & reel	L223
TS822AILT	1%				L222

## 5 Revision history

**Table 6. Document revision history**

Date	Revision	Changes
21-Mar-2002	1	Initial release.
20-Aug-2007	2	Removed information related to TO-92 package. Format update.



**Please Read Carefully:**

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

**UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.**

**UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.**

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2007 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

[www.st.com](http://www.st.com)

